ASSP Mobile Communication Systems

SAW Filter (700 to 1000 MHz)

F5CM Series (B2)

■ DESCRIPTION

The F5CM series of SAW filters have balanced in/unbalanced out or unbalanced in/balanced out of I/O ports. Therefore these filters are suitable for the design using balanced type of IC. By using these filters, any transforming devises, such as balun is not required.

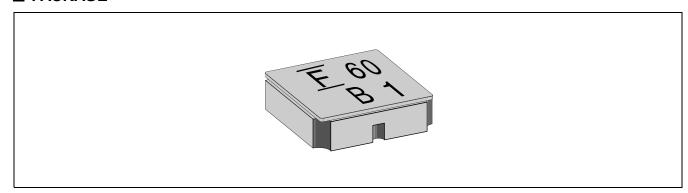
The F5CM series filters apply to the frequency range 700 to 1000MHz. High performance has been realized with high reliability and small size by using original materials and original design.

The F5CM series filters are suitable for RF interstage filter in mobile communication systems and standard parts are available for GSM and AMPS/TDMA/CDMA standards.

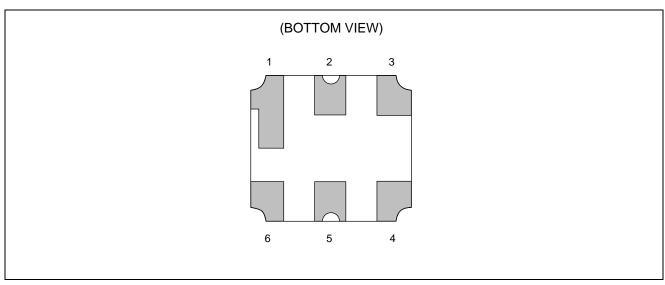
■ FEATURES

- Balanced/unbalanced I/O ports
- Ultra compact and light package (3.0 mm × 3.0 mm package)
- · Any external matching network is not required
- · Excellent stopband attenuation
- Small inband ripple
- Surface mount package (SMT)

■ PACKAGE



■ PIN ASSIGNMENT



■ PIN DESCRIPTION

• BALANCED IN/UNBALANCED OUT type (Tx filter)

Pin no.	Pin name	Description			
1	GND	Ground Pin			
2	OUT	Unbalanced output			
3	GND	Ground Pin			
4	IN	Balanced Input			
5	GND	Ground Pin			
6	IN	Balanced Input			

• UNBALANCED IN/BALANCED OUT type (Rx filter)

Pin no.	Pin name	Description
1	GND	Ground Pin
2	IN	Unbalanced Input
3	GND	Ground Pin
4	OUT	Balanced Output
5	GND	Ground Pin
6	OUT	Balanced Output

■ ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Rat	Unit	
Farameter	Symbol	Min.	Max.	Onit
Operating temperature	Та	-30	+85	°C
Storage temperature	Tstg	-40	+100	°C
Input power	Pin	_	+15	dBm
Input DC Voltage	DCin	-5	+5	V

WARNING: Piezoelectric devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

■ RECOMMENDED OPERATING CONDITION

Parameter	Symbol	Va	Unit	
Farameter	Symbol	Min. Max.		
Operating temperature	Та	-30	+85	°C

WARNING: The recommended operating conditions are required in order to ensure the normal operation of the piezoelectric device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use piezoelectric devices within their recommended operating conditionranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their FUJITSU representatives beforehand.

■ STANDARD FREQUENCIES

Applicati	ions	Frequency (MHz)	Band width (MHz)	Input type/ Impedance	Output type/ Impedance	Part number	Part symbol
0014	Тх	902.5	25	Balance 50 Ω	Unbalance50 Ω	FAR-F5CM-902M50-B263	63
GSM	Rx	947.5	25	Unbalance	Balance50 Ω	FAR-F5CM-947M50-B260	60
	INX.	3 4 1.3	25	50 Ω	Balance150 Ω	FAR-F5CM-947M50-B262	62
EGSM	Rx	942.5	35	Unbalance 50 Ω	Balance50 Ω	FAR-F5CM-942M50-B270	70
AMPS/ TDMA/	Тх	836.5	25	Balance 50 Ω	Unbalance50 Ω	FAR-F5CM-836M50-B268	68
CDMA	Rx	881.5	25	Unbalance 50 Ω	Balance50 Ω	FAR-F5CM-881M50-B266	66

■ ELECTRICAL CHARACTERISTICS

1. GSM (Tx) 50 ohms Balanced IN/50 ohms Unbalanced OUT Part number: FAR-F5CM-902M50-B263

 $(Ta = -30^{\circ}C \text{ to } + 85^{\circ}C)$

Parameter	Conditions		Value		Unit	Remarks
rarameter	Conditions	Min.	Тур.	Max.	Onit	Remarks
Insertion loss	890 to 915 MHz	_	3.2	3.5	dB	
Inband ripple	890 to 915 MHz	_	1.2	1.5	dB	
	DC to 845 MHz	45	58	_	dB	
	845 to 870 MHz	25	50	_	dB	
Absolute attenuation	935 to 980 MHz	25	30	_	dB	
alleridation	980 to 2000 MHz	40	58	_	dB	
	2000 to 3000 MHz	30	37	_	dB	

2. GSM (Rx) 50 ohms Unbalanced IN/50 ohms Balanced OUT Part number: FAR-F5CM-947M50-B260

 $(Ta = -30^{\circ}C \text{ to } + 85^{\circ}C)$

Parameter	Conditions		Value			Remarks
Parameter	Conditions	Min.	Тур.	Max.	Unit	Remarks
Insertion loss	935 to 960 MHz	_	3.0	3.3	dB	
Inband ripple	935 to 960 MHz	_	0.9	1.2	dB	
	DC to 890 MHz	45	56	_	dB	
	890 to 915 MHz	25	31	_	dB	
Absolute attenuation	980 to 1025 MHz	25	30	_	dB	
	1025 to 2000 MHz	40	50	_	dB	
	2000 to 3000 MHz	35	45	_	dB	

3. GSM (Rx) 50 ohms Unbalanced IN/150 ohms Balanced OUT Part number: FAR-F5CM-947M50-B262

 $(Ta = -30^{\circ}C \text{ to } + 85^{\circ}C)$

Parameter	Conditions		Value		Unit	Remarks
Farameter	Conditions	Min.	Тур.	Max.	Onit	Nemarks
Insertion loss	935 to 960 MHz	_	3.3	3.8	dB	
Inband ripple	935 to 960 MHz	_	0.8	1.3	dB	
	DC to 890 MHz	45	55	_	dB	
	890 to 915 MHz	25	48	_	dB	
Absolute attenuation	980 to 1025 MHz	23	29	_	dB	
dionadion	1025 to 2000 MHz	40	50	_	dB	
	2000 to 3000 MHz	35	39	_	dB	

4. EGSM (Rx) 50 ohms Unbalanced IN/50 ohms Balanced OUT Part number: FAR-F5CM-942M50-B270

 $(Ta = -30^{\circ}C \text{ to } + 85^{\circ}C)$

Parameter	Conditions		Value		Unit	Remarks
raiametei	Conditions	Min.	Тур.	Max.	Oilit	ixemai ks
Insertion loss	925 to 960 MHz	_	3.8	4.5	dB	
Inband ripple	925 to 960 MHz	_	1.8	2.5	dB	
	DC to 880 MHz	50	55	_	dB	
	880 to 915 MHz	15	22	_	dB	
Absolute attenuation	980 to 1025 MHz	23	27	_	dB	
attoriadion	1025 to 2000 MHz	40	44	_	dB	
	2000 to 3000 MHz	25	39	_	dB	

5. AMPS/TDMA/CDMA (Tx) 50 ohms Balanced IN/50 ohms Unbalanced OUT Part number: FAR-F5CM-836M50-B268

 $(Ta = -30^{\circ}C \text{ to } + 85^{\circ}C)$

Parameter	Conditions		Value		Unit	Remarks
r ai ailletei	Conditions	Min.	Тур.	Max.	Oilit	Nemarks
Insertion loss	824 to 849 MHz	_	2.8	3.5	dB	
Inband ripple	824 to 849 MHz	_	0.9	1.6	dB	
	DC to 800 MHz	45	52	_	dB	
Absolute	869 to 920 MHz	25	33	_	dB	
attenuation	920 to 2000 MHz	35	46	_	dB	
	2000 to 3000 MHz	25	33	_	dB	

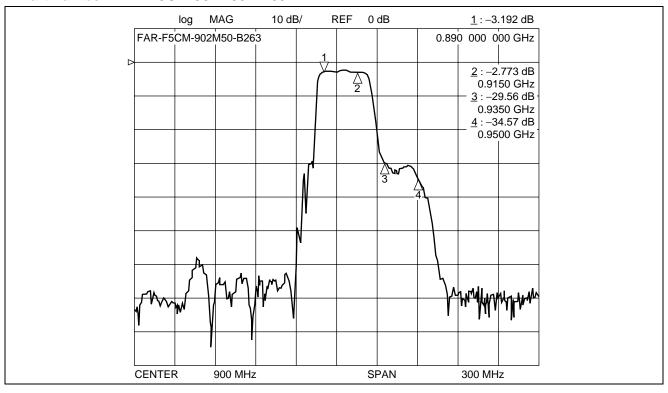
6. AMPS/TDMA/CDMA (Rx) 50 ohms Unbalanced IN/50 ohms Balanced OUT Part number: FAR-F5CM-881M50-B266

 $(Ta = -30^{\circ}C \text{ to } + 85^{\circ}C)$

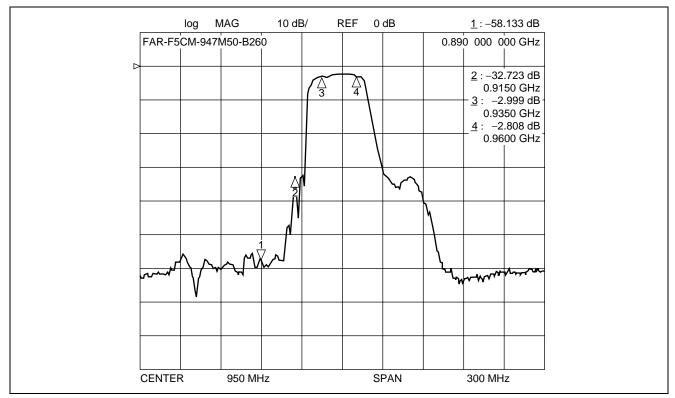
Parameter	Conditions		Value		Unit	Remarks
Farameter	Conditions	Min.	Тур.	Max.	Onit	Remarks
Insertion loss	869 to 894 MHz	_	2.8	3.5	dB	
Inband ripple	869 to 894 MHz	_	0.8	1.5	dB	
	DC to 800 MHz	45	55	_	dB	
	800 to 849 MHz	30	47	_	dB	
Absolute attenuation	940 to 1000 MHz	30	38	_	dB	
attorisation	1000 to 2000 MHz	35	47	_	dB	
	2000 to 3000 MHz	25	32	_	dB	

■ TYPICAL CHARACTERISTICS

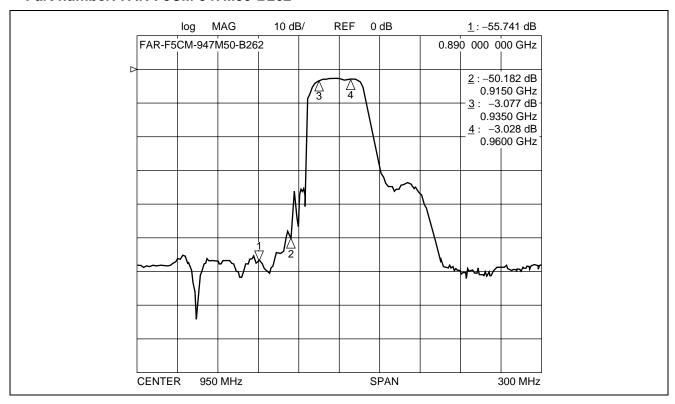
 GSM (Tx) 50 ohms Balanced IN/50 ohms Unbalanced OUT Part number: FAR-F5CM-902M50-B263



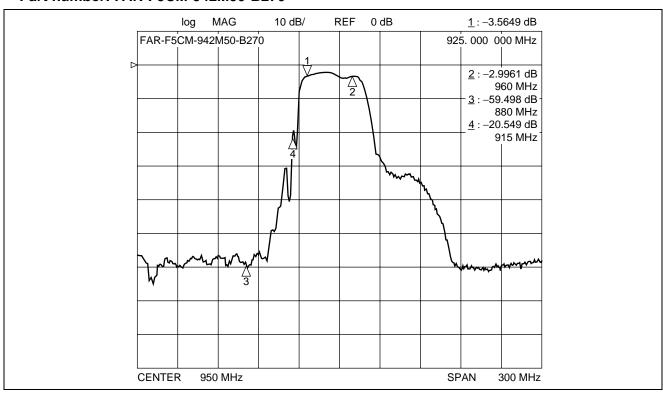
2. GSM (Rx) 50 ohms Unbalanced IN/50 ohms Balanced OUT Part number: FAR-F5CM-947M50-B260



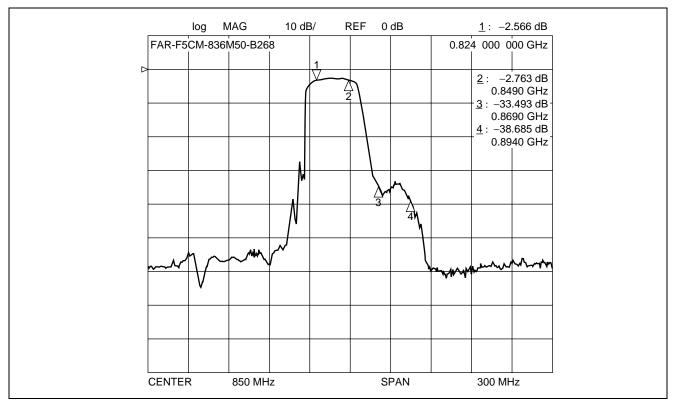
3. GSM (Rx) 50 ohms Unbalanced IN/150 ohms Balanced OUT Part number: FAR-F5CM-947M50-B262



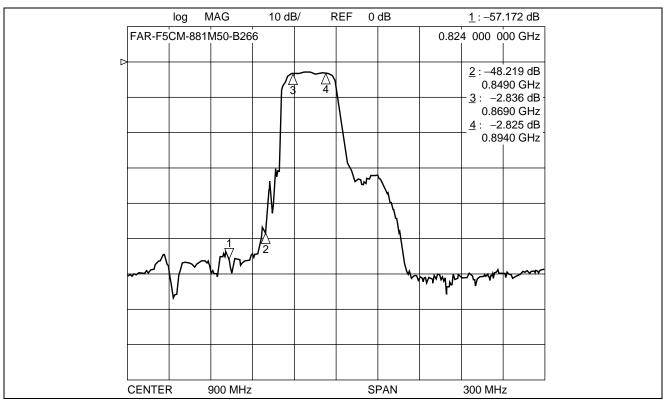
4. EGSM (Rx) 50 ohms Unbalanced IN/50 ohms Balanced OUT Part number: FAR-F5CM-942M50-B270



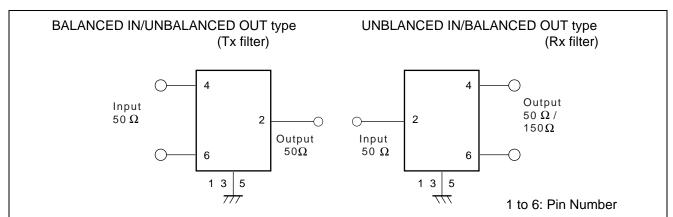
5. AMSP/TDMA/CDMA (Tx) 50 ohms Balanced IN/50 ohms Unbalanced OUT Part number: FAR-F5CM-836M50-B268



6. AMSP/TDMA/CDMA (Rx) 50 ohms Unbalanced IN/50 ohms Balanced OUT Part number: FAR-F5CM-881M50-B266



■ MEASURMENT CIRCUIT



Note: Attached frequency response plots are obtained by simulation using above S21, S31, S32, S11, S22, S33 of each characteristics. Electrical specifications are also decided based on these results.

■ PART NUMBER DESIGNATION

[Designation example]

(1) Frequency: Center frequency is specified in six alphanumeric.

Enter M (for MHz) at the decimal point.

Refer to below example.

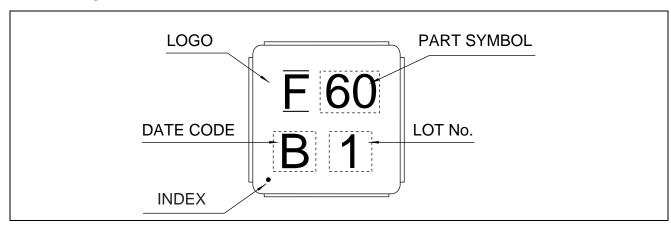
[Example] $902.5 \text{ MHz} \Rightarrow 902M50$

(2) Part symbol: Specified characters from 60 to 79.

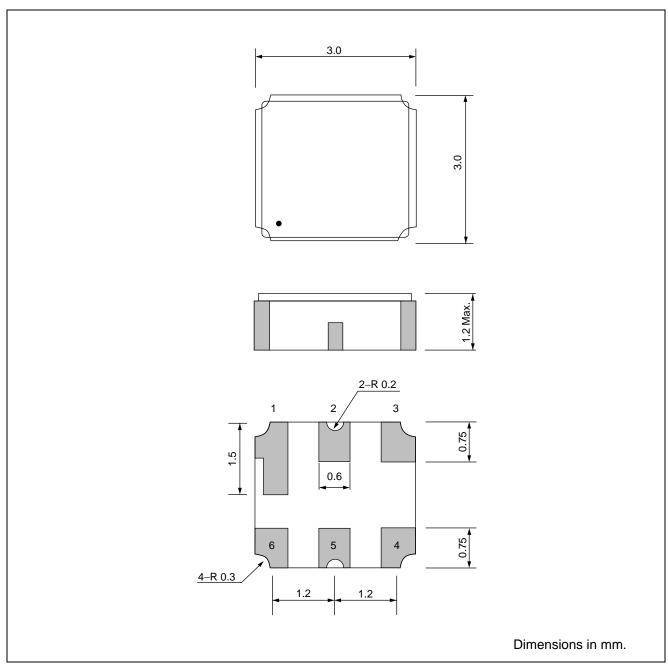
(3) Packing: W: 1000 pcs/reel V: 3000 pcs/reel

U: 5000 pcs/reel

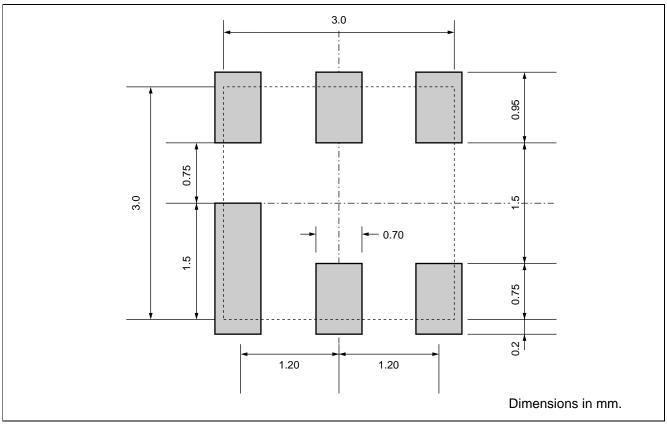
■ MARKING



■ PACKAGE DIMENSION

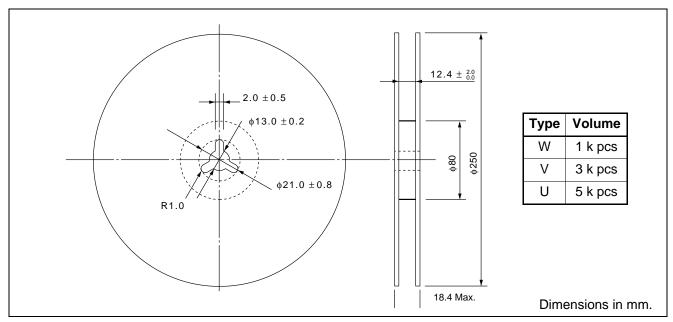


■ RECOMMENDED LAND PATTERN

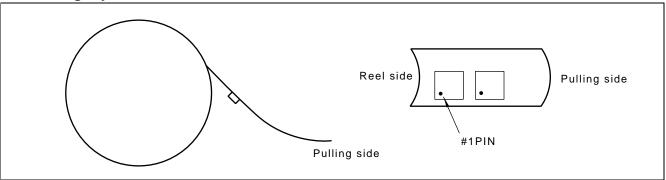


■ PACKING: Reel type

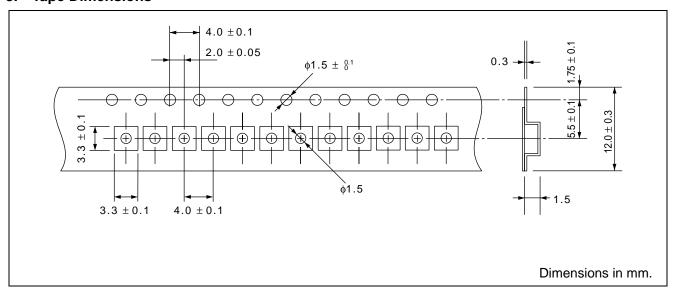
1. Reel Dimensions



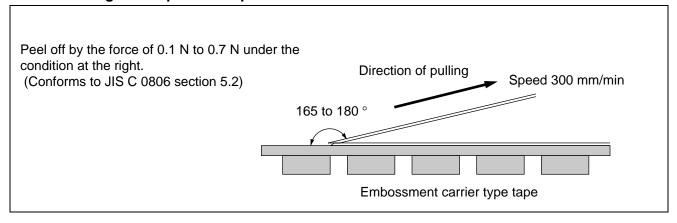
2. Packing Style



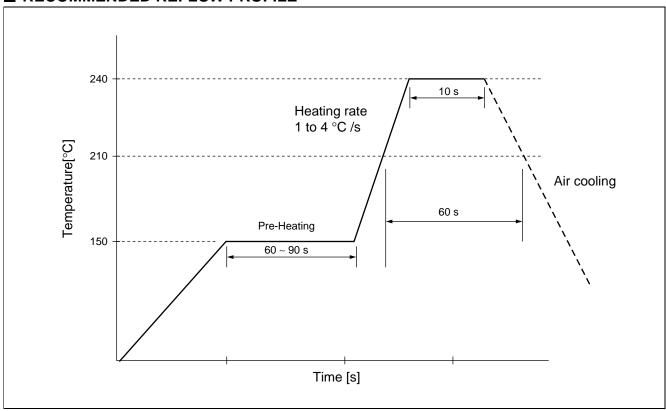
3. Tape Dimensions



4. Peel Strength of Top Cover Tape



■ RECOMMENDED REFLOW PROFILE



■ NOTE

Mass-produced product order is accepted by a unit of 1000.

FUJITSU MEDIA DEVICES LIMITED

For further information please contact:

Japan

FUJITSU MEDIA DEVICES LIMITED International Sales and Marketing Dept. Sin-Yokohama Square Bldg.,14F, Shin-Yokohama 2-3-12, Kouhoku-ku, Yokohama-shi, Kanagawa 222-0033, Japan

Tel: +81-45-471-0061 Fax: +81-45-471-0076

http://www.fujitsu.co.jp/hypertext/fmd/English/index.html

North and South America

FUJITSU MICROELECTRONICS, INC. 3545 North First Street, San Jose, CA 95134-1804, U.S.A. Tel: +1-408-922-9000

Tel: +1-408-922-9000 Fax: +1-408-922-9179

Customer Response Center Mon. - Fri.: 7 am - 5 pm (PST)

Tel: +1-800-866-8608 Fax: +1-408-922-9179 http://www.fujitsumicro.com/

Europe

FUJITSU MICROELECTRONICS EUROPE GmbH

Am Siebenstein 6-10,

D-63303 Dreieich-Buchschlag,

Germany

Tel: +49-6103-690-0 Fax: +49-6103-690-122 http://www.fujitsu-fme.com/

Asia Pacific

FUJITSU MICROELECTRONICS ASIA PTE. LTD. #05-08, 151 Lorong Chuan, New Tech Park,

Singapore 556741 Tel: +65-281-0770 Fax: +65-281-0220

http://www.fmap.com.sg/

F0010 © FUJITSU LIMITED Printed in Japan All Rights Reserved.

The contents of this document are subject to change without notice. Customers are advised to consult with FUJITSU sales representatives before ordering.

The information and circuit diagrams in this document are presented as examples of semiconductor device applications, and are not intended to be incorporated in devices for actual use. Also, FUJITSU is unable to assume responsibility for infringement of any patent rights or other rights of third parties arising from the use of this information or circuit diagrams.

The contents of this document may not be reproduced or copied without the permission of FUJITSU LIMITED.

FUJITSU semiconductor devices are intended for use in standard applications (computers, office automation and other office equipments, industrial, communications, and measurement equipments, personal or household devices, etc.).

CAUTION:

Customers considering the use of our products in special applications where failure or abnormal operation may directly affect human lives or cause physical injury or property damage, or where extremely high levels of reliability are demanded (such as aerospace systems, atomic energy controls, sea floor repeaters, vehicle operating controls, medical devices for life support, etc.) are requested to consult with FUJITSU sales representatives before such use. The company will not be responsible for damages arising from such use without prior approval.

Any semiconductor devices have inherently a certain rate of failure. You must protect against injury, damage or loss from such failures by incorporating safety design measures into your facility and equipment such as redundancy, fire protection, and prevention of over-current levels and other abnormal operating conditions.

If any products described in this document represent goods or technologies subject to certain restrictions on export under the Foreign Exchange and Foreign Trade Control Law of Japan, the prior authorization by Japanese government should be required for export of those products from Japan. This datasheet has been download from:

www.datasheetcatalog.com

Datasheets for electronics components.